

Chromophore ordering by confinement into carbon nanotubes

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Supporting information :

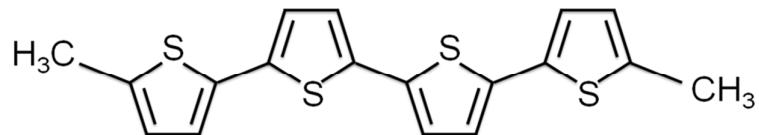


Figure 1: Structure of the 5,5''-Dimethyl-2,2':5',2''-quaterthiophene ($C_{18}H_{14}S_4$) called for simplicity dimethyl-quaterthiophene (4T) in the text.

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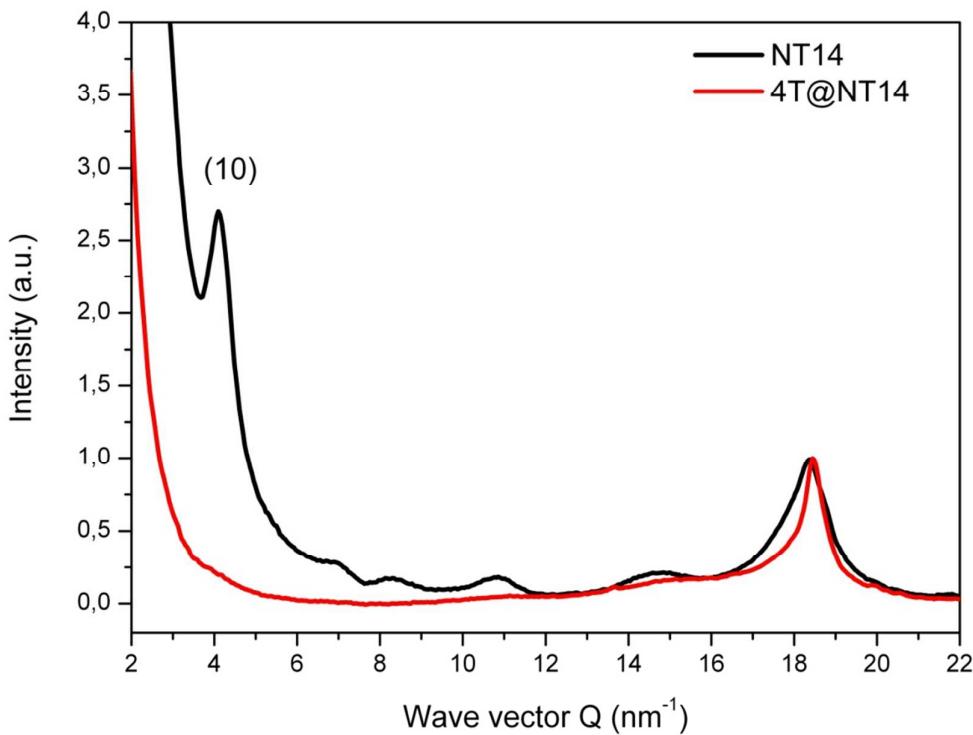


Figure 2: X-ray diffraction pattern recorded with a X-ray wavelength of 1.542 \AA of empty NT14 and filled with 4T (4T@NT14). The 10 peak vanishes after encapsulation due to interference effects (N. BENDIAB *et al.* PHYSICAL REVIEW B 69, 195415, 2004), evidencing the encapsulation efficiency.

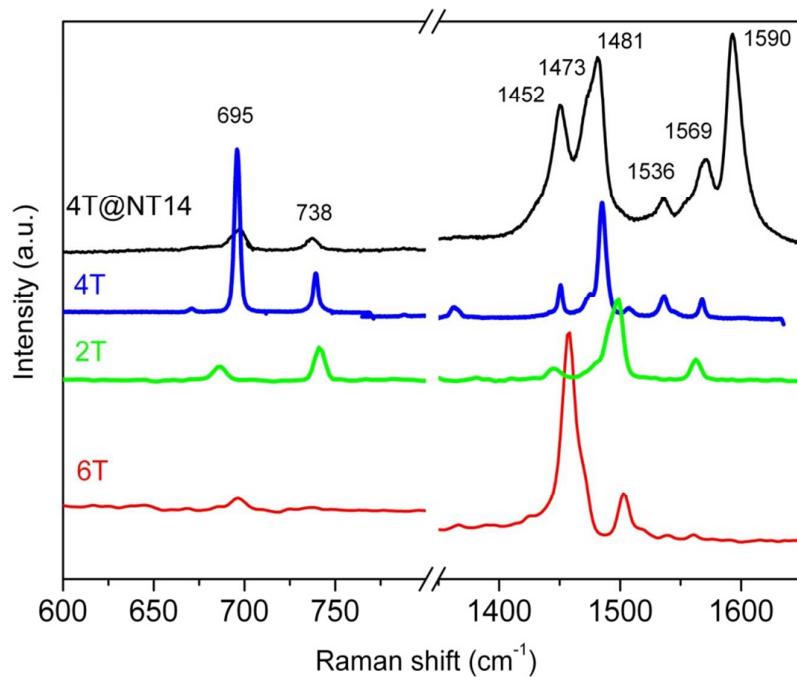


Figure 3: Raman spectra of dimethyl-bithiophene (2T), dimethyl quaterthiophene (4T), sexithiophene (6T) and 4T confined into nanotubes (4T@NT14).

The Raman signal after encapsulation clearly correspond to the 4T response, meaning that the molecules were not modified by the encapsulation process.